Unit: mm

TOSHIBA Diode Silicon Epitaxial Planar Type

1SS301

Ultra High Speed Switching Application

- AEC-Q101 Qualified (Note1)
- Small package
- Low forward voltage : VF (3) = 0.90 V (typ.)

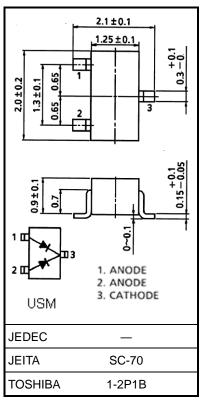
: SC-70

- Fast reverse recovery time : trr = 1.6 ns (typ.)
- Small total capacitance : CT = 0.9 pF (typ.)

Note 1: For detail information, please contact our sales.

Characteristic	Symbol	Rating	Unit	
Maximum (peak) reverse voltage	V _{RM}	85	V	
Reverse voltage	VR	80	V	
Maximum (peak) forward current	I _{FM}	300 *	mA	
Average forward current	IO	100 *	mA	
Surge current (10ms)	IFSM	2 *	А	
Power dissipation	P _D (Note 2, 4)	200	mW	
	P _D (Note 3)	100		
Junction temperature	Tj (Note 2)	150	°C	
	Tj (Note 3)	125		
Storage temperature	T _{stg} (Note 2)	-55 to 150		
	T _{stg} (Note 3)	-55 to 125	°C	

Absolute Maximum Ratings (Ta = 25°C)



Weight: 0.006 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: For devices with the ordering part number ending in LF(T.

Note 3: For devices with the ordering part number in other than LF(T.

Note 4: Mounted on a FR4 board. (25.4 mm \times 25.4 mm \times 1.6 mm, Cu pad: 0.5 mm² \times 3)

*: Unit rating. Total rating = Unit rating × 1.5.

Start of commercial production 1986-11

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Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	VF (1)	I _F = 1 mA	_	0.60	_	V
	VF (2)	IF = 10 mA	-	0.72	-	
	VF (3)	I _F = 100 mA	-	0.90	1.20	
Reverse current	I _{R (1)}	V _R = 30 V	-	—	0.1	μA
	IR (2)	VR = 80 V	_	_	0.5	
Total capacitance	CT	V _R = 0 V, f = 1 MHz	_	0.9	3.0	pF
Reverse recovery time	t _{rr}	I _F = 10 mA (Fig.1)	_	1.6	4.0	ns

Marking



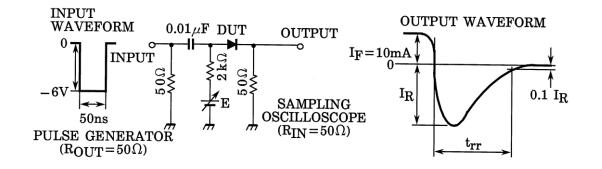
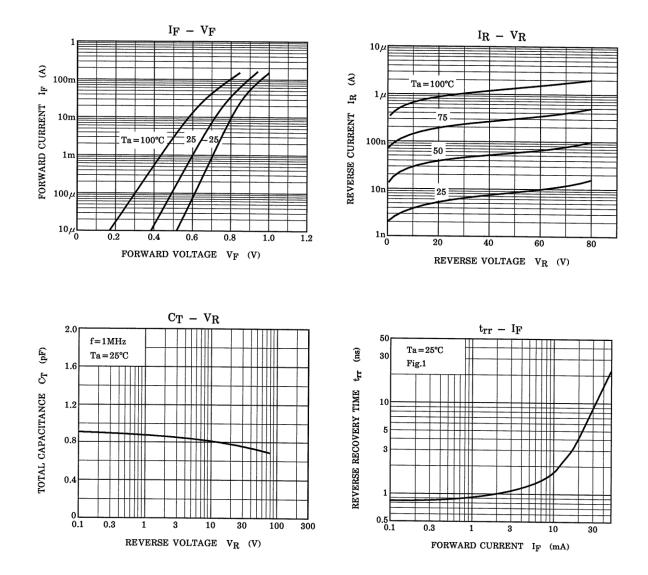


Fig.1 Reverse Recovery Time (trr) Test Circuit

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Characteristics Curves



The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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